

# EB51F5G30BV-44.736M

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## REGULATORY COMPLIANCE (Data Sheet downloaded on May 2, 2016)



## ITEM DESCRIPTION

Temperature Compensated Quartz Crystal Clock Oscillators TCXO HCMOS (CMOS) 5.0Vdc 14-Pin DIP Metal Thru-Hole 44.736MHz  $\pm 1.0\text{ppm}$  Maximum  $\pm 3.0\text{ppm}$  Maximum  $0^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$

## ELECTRICAL SPECIFICATIONS

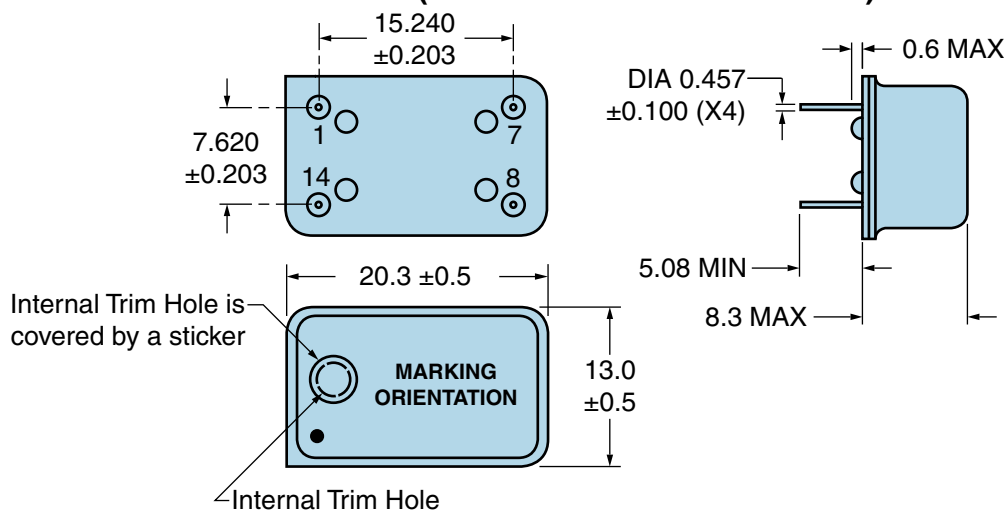
Nominal Frequency	44.736MHz
Initial Tolerance	$\pm 1.0\text{ppm}$ Maximum (Measured at Nominal Vdd and Vc)
Frequency Stability	$\pm 3.0\text{ppm}$ Maximum
Frequency Stability vs. Input Voltage	$\pm 0.3\text{ppm}$ Maximum (Vdd $\pm 5\%$ )
Frequency Stability vs. Load	$\pm 0.2\text{ppm}$ Maximum ( $\pm 10\%$ )
Frequency Stability vs. Aging	$\pm 1\text{ppm/Year}$ Maximum (at $25^{\circ}\text{C}$ )
Operating Temperature Range	$0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$
Supply Voltage	5.0Vdc $\pm 5\%$
Input Current	30mA Maximum (Measured at Steady State at $25^{\circ}\text{C}$ )
Output Voltage Logic High (Voh)	Vdd-0.5Vdc Minimum
Output Voltage Logic Low (Vol)	0.5Vdc Maximum
Rise/Fall Time	6nSec Maximum (Measured at 20% to 80% of waveform)
Duty Cycle	50% $\pm 5\%$ (Measured at 50% of waveform)
Load Drive Capability	30pF HCMOS Load Maximum
Output Logic Type	CMOS
Control Voltage	2.5Vdc $\pm 2.0\text{Vdc}$
Control Voltage Range	0.0Vdc to Vdd
Frequency Deviation	$\pm 7\text{ppm}$ Minimum, $\pm 20\text{ppm}$ Maximum (Referenced to Fo at Vc=2.5Vdc; Vdd=5.0Vdc)
Linearity	$\pm 10\%$ Maximum
Internal Trim	$\pm 3\text{ppm}$ Minimum (at $25^{\circ}\text{C}$ , Top Access)
Input Impedance	10kOhms Typical
Phase Noise	-70dBc/Hz at 10Hz Offset, -100dBc/Hz at 100Hz Offset, -130dBc/Hz at 1kHz Offset, -140dBc/Hz at 10kHz Offset, -145dBc/Hz at 100kHz Offset (Typical Values at 19.440MHz)
Storage Temperature Range	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

Fine Leak Test	MIL-STD-883, Method 1014 Condition A (Internal Crystal Only)
Gross Leak Test	MIL-STD-883, Method 1014 Condition C (Internal Crystal Only)
Lead Integrity	MIL-STD-883, Method 2004
Mechanical Shock	MIL-STD-202, Method 213 Condition C
Resistance to Soldering Heat	MIL-STD-202, Method 210
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003
Temperature Cycling	MIL-STD-883, Method 1010
Vibration	MIL-STD-883, Method 2007 Condition A

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## MECHANICAL DIMENSIONS (all dimensions in millimeters)

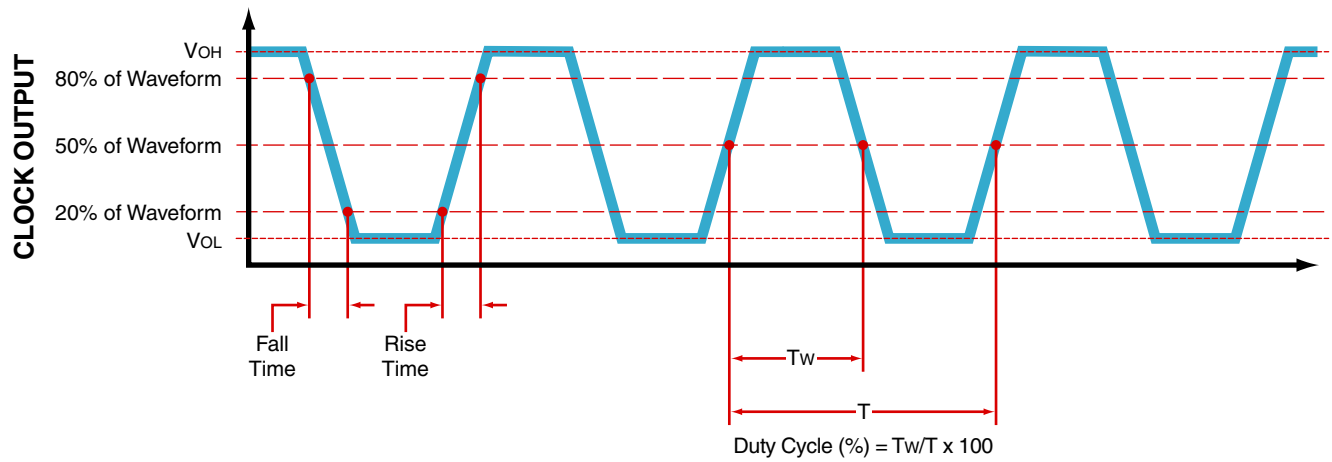


LINE	MARKING
1	ECLIPTEK
2	44.736M
3	<b>XXYYZZ</b> XX=Ecliptek Manufacturing Code Y=Last Digit of the Year ZZ=Week of the Year

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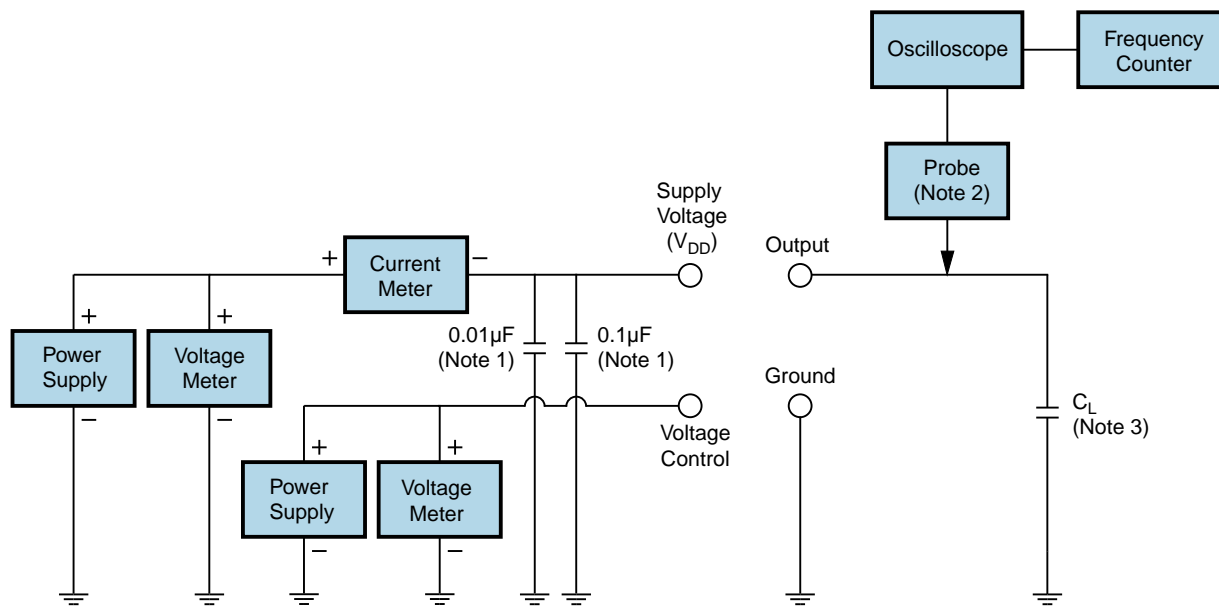
## OUTPUT WAVEFORM



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## Test Circuit for Voltage Control Option



Note 1: An external 0.1µF low frequency tantalum bypass capacitor in parallel with a 0.01µF high frequency ceramic bypass capacitor close to the package ground and  $V_{DD}$  pin is required.

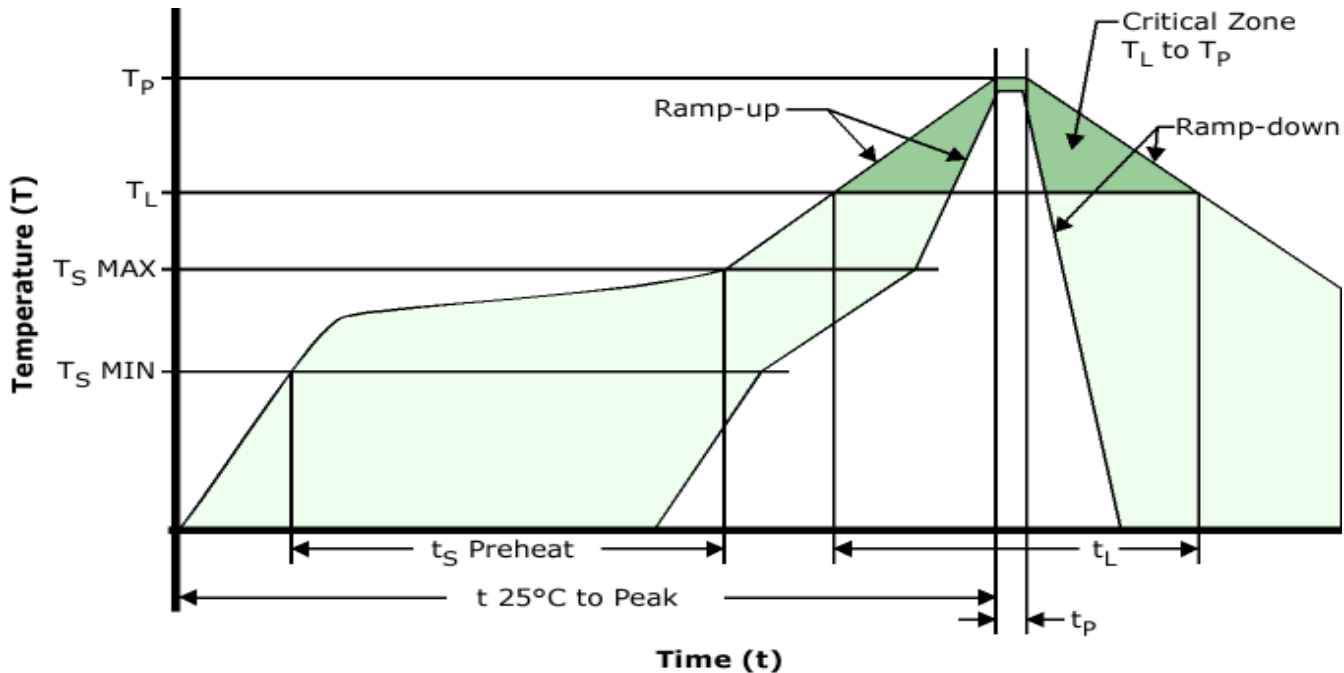
Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.

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## Recommended Solder Reflow Methods



### Low Temperature Solder Bath (Wave Solder)

<b>T<sub>s</sub> MAX to T<sub>L</sub> (Ramp-up Rate)</b>	5°C/Second Maximum
<b>Preheat</b>	
- Temperature Minimum (T <sub>s</sub> MIN)	N/A
- Temperature Typical (T <sub>s</sub> TYP)	150°C
- Temperature Maximum (T <sub>s</sub> MAX)	N/A
- Time (t <sub>s</sub> MIN)	30 - 60 Seconds
<b>Ramp-up Rate (T<sub>L</sub> to T<sub>P</sub>)</b>	5°C/Second Maximum
<b>Time Maintained Above:</b>	
- Temperature (T <sub>L</sub> )	150°C
- Time (t <sub>L</sub> )	200 Seconds Maximum
<b>Peak Temperature (T<sub>P</sub>)</b>	245°C Maximum
<b>Target Peak Temperature (T<sub>P</sub> Target)</b>	245°C Maximum 1 Time / 235°C Maximum 2 Times
<b>Time within 5°C of actual peak (t<sub>p</sub>)</b>	5 Seconds Maximum 1 Time / 15 Seconds Maximum 2 Times
<b>Ramp-down Rate</b>	5°C/Second Maximum
<b>Time 25°C to Peak Temperature (t)</b>	N/A
<b>Moisture Sensitivity Level</b>	Level 1

### Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

### High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.